# imall

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### **General Description**

The MAX6439–MAX6442 are a family of ultra-low-power battery monitors with integrated microprocessor ( $\mu$ P) supervisors. The battery monitors are offered with single or dual low-battery output options that can be used to signal when the battery is OK (enabling full system operation), when the battery is low (for low-power system operation), and when the battery is dead (to disable system operation). These devices also have an independent  $\mu$ P supervisor that monitors V<sub>CC</sub> and provides an active-low reset output. A manual reset function is available to reset the  $\mu$ P with a push-button. No external components are required.

The MAX6439–MAX6442 are offered with several factory-trimmed low-battery threshold combinations ideal for single-cell lithium-ion (Li+) or multicell alkaline/NiCd/ NiMH applications. When the battery voltage drops below each specified low threshold, the low-battery outputs are asserted to alert the system. When the voltage rises above the specified high thresholds, the outputs are deasserted after a 150ms minimum timeout period, ensuring the voltages have stabilized before power circuitry is activated or providing microprocessor reset timing. The low and high thresholds provide hysteresis in battery-operated systems to eliminate output chattering.

The MAX6439/MAX6440 offer factory-trimmed battery monitors with a single output. The MAX6441/MAX6442 offer factory-trimmed battery monitors with dual outputs. All battery monitors have open-drain low-battery outputs.

The MAX6439–MAX6442 monitor system voltages (V<sub>CC</sub>) from 1.8V to 3.3V with seven fixed reset threshold options. Each device is offered with two minimum reset timeout periods of 150ms or 1200ms. The MAX6439/ MAX6441 are offered with an open-drain RESET output and the MAX6440/MAX6442 are offered with a push-pull RESET output.

The MAX6439–MAX6442 are offered in a SOT23 package and are fully specified over a -40°C to +85°C temperature range.

#### **Applications**

- Battery-Powered Systems (Single-Cell Li+ or Two-/Three-Cell NiMH, NiCd, Alkaline)
- Cell Phones/Cordless Phones
- Portable Medical Devices
- Electronic Toys
- Pagers
- PDAs
- MP3 Players

 Factory-Trimmed V<sub>BATT</sub> Threshold Options for Monitoring Single-Cell Li+ or Multicell Alkaline/NiCd/NiMH Applications

- Immune to Short Battery Voltage Transients
- ♦ Low Current (2.5µA typ at 3.6V)
- Single and Dual Low-Battery Output Options
- ♦ 150ms Minimum LBO Timeout Period
- ♦ Independent µP Reset with Manual Reset
- Factory-Set Reset Thresholds for Monitoring V<sub>CC</sub> from 1.8V to 3.3V
- Available with 150ms (min) and 1.2s (min) V<sub>CC</sub> Reset Timeout Period Options
- ◆ -40°C to +85°C Operating Temperature Range
- Small 6- and 8-Pin SOT23 Packages
- No External Components

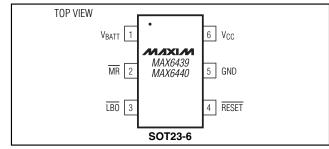
#### **\_Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE
MAX6439UTDT	-40°C to +85°C	6 SOT23-6
MAX6440UTDT	-40°C to +85°C	6 SOT23-6
MAX6441KADT	-40°C to +85°C	8 SOT23-8
MAX6442KADT	-40°C to +85°C	8 SOT23-8

**Note:** The first two "\_\_\_" are placeholders for the battery monitor voltage levels. Desired threshold levels are set by the part number suffix found in Tables 1 and 2. The third "\_" is the V<sub>CC</sub> reset threshold level suffix found in Table 3. The "\_" after the D is a placeholder for the reset timeout period suffix found in Table 4. All devices are available in tape-and-reel only. There is a 2500-piece minimum order increment for standard versions. Sample stock is typically held on standard versions only. Nonstandard versions require a minimum order increment of 10,000 pieces. Contact factory for availability.

Devices are available in both leaded and lead-free packaging. Specify lead-free by replacing "-T" with "+T" when ordering.

#### Pin Configurations



Pin Configurations continued at end of data sheet.

\_ Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

**Features** 

#### **ABSOLUTE MAXIMUM RATINGS**

VBATT, VCC to GND	-0.3V to +6V*
Open-Drain LBO, LBOH, LBOL,	
Open-Drain RESET to GND	
Push-Pull RESET to GND	0.3V to (V <sub>CC</sub> + 0.3V)
MR to GND	0.3V to (V <sub>CC</sub> + 0.3V)
Input/Output Current, All Pins	
Continuous Power Dissipation (T	$A = +70^{\circ}C$
6-Pin SOT23 (derate 8.7mW/°	C above +70°C)695mW

6-Pin SOT23 (derate 8.7mW/°C above +70°C	)695mW

8-Pin SOT23 (derate 8.9mW/°C above +70°C)......714mW

Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	

\*Applying 7V for a duration of 1ms does not damage the device.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### ELECTRICAL CHARACTERISTICS

(VBATT = 1.2V to 5.5V, V<sub>CC</sub> = 1.2V to 5.5V, T<sub>A</sub> = -40°C to +85°C, unless otherwise specified. Typical values are at T<sub>A</sub> = +25°C.) (Note1)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
	\/	$T_A = 0^{\circ}C$ to $+85^{\circ}C$	1.0		5.5	V
VBATT Operating Voltage Range	VBATT	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			5.5	V
		$T_A = 0^{\circ}C \text{ to } +85^{\circ}C$	1.0		5.5	
V <sub>CC</sub> Operating Voltage Range	Vcc	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	1.2		5.5	V
V <sub>CC</sub> + V <sub>BATT</sub> Supply Current	I <sub>CC</sub> + I <sub>BATT</sub>	V <sub>BATT</sub> = 3.6V, V <sub>CC</sub> = 3.3V, no load (Note 2)		2.5	7	μA
VBATT THRESHOLDS		·				
		MAX6439UT_ J, MAX6440UT_ J	3.510	3.60	3.690	
		MAX6439UT_ I, MAX6440UT_ I	3.413	3.50	3.588	
		MAX6439UT_ H, MAX6440UT_ H	3.315	3.40	3.485	
		MAX6439UT_ G, MAX6440UT_ G	3.218	3.30	3.383	V
HTH Threshold	НТН	MAX6439UT_ T, MAX6440UT_ T	2.535	2.60	2.665	
		MAX6439UT_S, MAX6440UT_S	2.438	2.50	2.563	
		MAX6439UT_ R, MAX6440UT_ R	2.340	2.40	2.460	
		MAX6439UT_ Q, MAX6440UT_ Q	2.243	2.30	2.358	
		MAX6439UTF, MAX6440UTF	3.023	3.10	3.178	
		MAX6439UTE, MAX6440UTE	2.925	3.00	3.075	
		MAX6439UTD, MAX6440UTD	2.828	2.90	2.973	1
		MAX6439UTC, MAX6440UTC	2.730	2.80	2.870	
		MAX6439UTB, MAX6440UTB	2.633	2.70	2.768	
		MAX6439UTA, MAX6440UTA	2.535	2.60	2.665	
LTH Threshold	LTH	MAX6439UTP, MAX6440UTP	2.048	2.10	2.153	V
		MAX6439UTO, MAX6440UTO	1.950	2.00	2.050	
		MAX6439UTN, MAX6440UTN	1.853	1.90	1.948	
		MAX6439UTM, MAX6440UTM	1.755	1.80	1.845	
		MAX6439UTL, MAX6440UTL	1.658	1.70	1.743	
		MAX6439UTK, MAX6440UTK	1.560	1.60	1.640	



## **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{BATT} = 1.2V \text{ to } 5.5V, V_{CC} = 1.2V \text{ to } 5.5V, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise specified. Typical values are at } T_A = +25^{\circ}C.)$  (Note1)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	МАХ	UNITS	
		MAX6441UT_ J, MAX6442UT_ J	3.510	3.600	3.690		
		MAX6441UT_ I, MAX6442UT_ I	3.413	3.500	3.588	]	
		MAX6441UT_ H, MAX6442UT_ H	3.315	3.400	3.485	]	
		MAX6441UT_ G, MAX6442UT_ G	3.218	3.300	3.383	V	
HTH- Threshold	HTH-	MAX6441UT_ T, MAX6442UT_ T	2.535	2.600	2.665	V	
		MAX6441UT_ S, MAX6442UT_ S	2.438	2.500	2.563		
		MAX6441UT_ R, MAX6442UT_ R	2.340	2.400	2.460		
		MAX6441UT_ Q, MAX6442UT_ Q	2.243	2.300	2.358		
		MAX6441UT_ J, MAX6442UT_ J	3.686	3.780	3.875		
		MAX6441UT_ I, MAX6442UT_ I	3.583	3.675	3.767		
		MAX6441UT_ H, MAX6442UT_ H	3.481	3.570	3.659		
		MAX6441UT_ G, MAX6442UT_ G	3.378	3.465	3.552		
HTH+ Threshold	HTH+	MAX6441UT_ T, MAX6442UT_ T	2.662	2.730	2.798	V	
		MAX6441UT_ S, MAX6442UT_ S	2.559	2.625	2.691		
		MAX6441UT_R, MAX6442UT_R	2.457	2.520	2.583		
		MAX6441UT_ Q, MAX6442UT_ Q	2.355	2.415	2.476		
		MAX6441UTF, MAX6442UTF	3.023	3.100	3.178	V	
		MAX6441UTE, MAX6442UTE	2.925	3.000	3.075		
		MAX6441UTD, MAX6442UTD	2.828	2.900	2.973		
		MAX6441UTC, MAX6442UTC	2.730	2.800	2.870		
		MAX6441UTB, MAX6442UTB	2.633	2.700	2.768		
LTIL Thursday		MAX6441UTA, MAX6442UTA	2.535	2.600	2.665		
LTH- Threshold	LTH-	MAX6441UTP, MAX6442UTP	2.048	2.100	2.153		
		MAX6441UTO, MAX6442UTO	1.950	2.000	2.050		
		MAX6441UTN, MAX6442UTN	1.853	1.900	1.948		
		MAX6441UTM, MAX6442UTM	1.755	1.800	1.845		
		MAX6441UTL, MAX6442UTL	1.658	1.700	1.743		
		MAX6441UTK, MAX6442UTK	1.560	1.600	1.640		
		MAX6441UTF, MAX6442UTF	3.174	3.255	3.337		
		MAX6441UTE, MAX6442UTE	3.071	3.150	3.229	1	
		MAX6441UTD, MAX6442UTD	2.969	3.045	3.121		
		MAX6441UTC, MAX6442UTC	2.867	2.940	3.014		
		MAX6441UTB, MAX6442UTB	2.764	2.835	2.906		
LTH+ Threshold		MAX6441UTA, MAX6442UTA	2.662	2.730	2.798	İ.,	
	LTH+	MAX6441UTP, MAX6442UTP	2.150	2.205	2.260	V	
		MAX6441UTO, MAX6442UTO	2.048	2.100	2.153		
		MAX6441UTN, MAX6442UTN	1.945	1.995	2.045	1	
		MAX6441UTM, MAX6442UTM	1.843	1.890	1.937	1	
		MAX6441UTL, MAX6442UTL	1.740	1.785	1.830	1	
		MAX6441UTK, MAX6442UTK	1.638	1.680	1.722	İ	

## **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{BATT} = 1.2V \text{ to } 5.5V, V_{CC} = 1.2V \text{ to } 5.5V, T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise specified. Typical values are at } T_A = +25^{\circ}\text{C}.)$  (Note1)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS	
IBO, IBOL, IBOH, IBOLH Timeout Period	tlbop	V <sub>BATT</sub> rising above threshold	150	225	300	ms	
LBO, LBOL, LBOH, LBOLH Delay Time	tlbod	VBATT falling below threshold		100		μs	
		(V <sub>BATT</sub> or V <sub>CC</sub> ) $\ge$ 1.2V, I <sub>SINK</sub> = 50µA, asserted low			0.3		
LBO, LBOL, LBOH, LBOLH		$(V_{BATT} \text{ or } V_{CC}) \ge 1.6V, I_{SINK} = 100 \mu A,$ asserted low			0.3	V	
Output Low (Open Drain)	V <sub>OL</sub>	$(V_{BATT} \text{ or } V_{CC}) \ge 2.7V, I_{SINK} = 1.2mA,$ asserted low			0.3	V	
		$(V_{BATT} \text{ or } V_{CC}) \ge 4.5V, I_{SINK} = 3.2mA,$ asserted low			0.3		
LBO, LBOL, LBOH, LBOLH Output Open-Drain Leakage Current	Ilkg	Output deasserted			500	nA	
		MAX64T	3.000	3.075	3.150	V	
		MAX64S	2.850	2.925	3.000		
	V <sub>TH</sub>	MAX64R	2.550	2.625	2.700		
V <sub>CC</sub> Reset Threshold		MAX64Z	2.250	2.313	2.375		
		MAX64Y	2.125	2.188	2.250		
		MAX64W	1.620	1.665	1.710		
		MAX64V	1.530	1.575	1.620		
V <sub>CC</sub> Reset Hysteresis				0.3		%	
V <sub>CC</sub> to RESET Delay		$V_{CC}$ falling at 10mV/µs from (V <sub>TH</sub> + 100mV) to (V <sub>TH</sub> - 100mV)		50		μs	
		MAX64D3	150	225	300		
$V_{CC}$ to RESET Timeout Period	t <sub>RP</sub>	MAX64D7	1200	1800	2400	ms	
	VIL			C	).3 x V <sub>CC</sub>		
MR Input Voltage	VIH		0.7 x V <sub>C</sub>	С		V	
MR Minimum Pulse Width	tMPW		1			μs	
MR Glitch Rejection			1	100		ns	
MR to RESET Delay			1	200		ns	
MR Reset Timeout Period	t <sub>MRP</sub>		150	225	300	ms	
MR Pullup Resistance		MR to V <sub>CC</sub>	750	1500	2250	Ω	
MR Rising Debounce Period	t <sub>DEB</sub>	(Note 3)	150	225	300	ms	

## **ELECTRICAL CHARACTERISTICS (continued)**

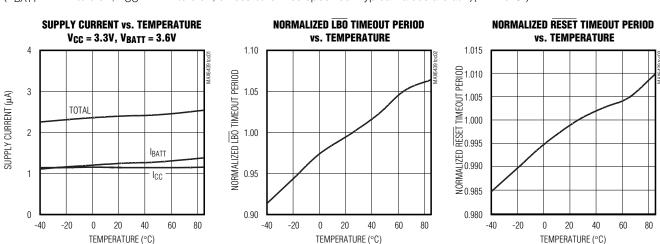
 $(V_{BATT} = 1.2V \text{ to } 5.5V, V_{CC} = 1.2V \text{ to } 5.5V, T_{A} = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise specified. Typical values are at T_{A} = +25^{\circ}C.)$  (Note1)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
RESET Output High	\/	$V_{CC} \ge 1.53V$ , $I_{SOURCE} = 100\mu A$ , $\overline{RESET}$ 0.8 x V <sub>C</sub> deasserted				V
(Push-Pull) VOH		V <sub>CC</sub> ≥ 2.55V, I <sub>SOURCE</sub> = 500µA, RESET deasserted	0.8 x V <sub>CC</sub>		V	
		$V_{CC} \ge 1.0V$ , $I_{SINK} = 50\mu A$ , RESET asserted			0.3	
	Max	$V_{CC} \ge 1.2V$ , $I_{SINK} = 100\mu A$ , RESET asserted			0.3	V
RESET Output Low	V <sub>OL</sub>	V <sub>CC</sub> ≥ 2.12V, I <sub>SINK</sub> = 1.2mA, RESET asserted			0.3	v
RESET Output Leakage Current (Open Drain)		RESET deasserted			500	nA

Note 1: Production testing done at  $T_A = +25^{\circ}C$ ; limits over temperature guaranteed by design only.

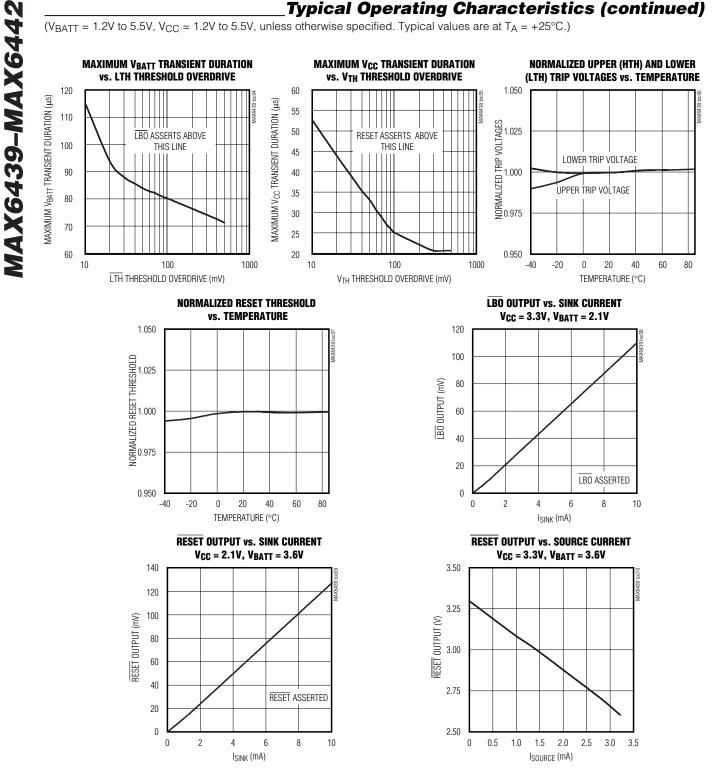
**Note 2:** The device is powered up by the highest voltage between  $V_{BATT}$  and  $V_{CC}$ .

**Note 3:** MR input ignores falling input pulses, which occur within the MR debounce period (t<sub>DEB</sub>) after a valid MR reset assertion. This prevents invalid reset assertion due to switch bounce.



## **Typical Operating Characteristics**

(V<sub>BATT</sub> = 1.2V to 5.5V, V<sub>CC</sub> = 1.2V to 5.5V, unless otherwise specified. Typical values are at  $T_A = +25^{\circ}C.$ )



## \_Pin Description

Р	IN		
MAX6439/ MAX6440	MAX6441/ MAX6442	NAME	FUNCTION
1	1	VBATT	Battery Voltage Input. Input for battery voltage threshold monitors and device power supply if $V_{\text{BATT}}$ is greater than $V_{\text{CC}}.$
2	3	MR	Manual Reset Input, Active-Low, Internal 1.5k $\Omega$ Pullup to V <sub>CC</sub> . Pull low to assert a one-shot edge-triggered RESET output for the $\overline{\text{MR}}$ reset timeout period. Leave unconnected or connect to V <sub>CC</sub> if unused. The $\overline{\text{MR}}$ input is debounced for $\overline{\text{MR}}$ rising edges to prevent false reset events.
3		LBO	Low-Battery Output, Active Low, Open Drain. $\overline{\text{LBO}}$ is asserted when VBATT drops below the LTH specification and remains asserted until VBATT rises above the HTH specification for at least 150ms.
4	5	RESET	Reset Output, Active Low, Push-Pull or Open Drain. RESET changes from high to low when the V <sub>CC</sub> input drops below the selected reset threshold and remains low for the V <sub>CC</sub> reset timeout period after V <sub>CC</sub> exceeds the reset threshold. RESET is one-shot edge-trigger pulsed low for the MR reset timeout period when the MR input is pulled low. RESET is an open-drain output for the MAX6439/MAX6441, and a push-pull output for the MAX6440. The push-pull outputs are referenced to V <sub>CC</sub> . RESET is guaranteed to be in the correct logic state for V <sub>BATT</sub> or V <sub>CC</sub> > 1.0V.
5	2	GND	Ground
6	8	V <sub>CC</sub>	$V_{CC}$ Voltage Input. Input for $V_{CC}$ reset threshold monitor and device power supply if $V_{CC}$ is greater than $V_{BATT}.$
_	6	LBOH	Low-Battery Output High, Active Low, Open Drain. $\overline{\text{LBOH}}$ is asserted when VBATT drops below the HTH- specification. $\overline{\text{LBOH}}$ is deasserted when VBATT rises above the HTH+ specification for at least 150ms.
	7	LBOL	Low-Battery Output Low, Active Low, Open Drain. $\overline{\text{LBOL}}$ is asserted when VBATT drops below the LTH- specification. $\overline{\text{LBOL}}$ is deasserted when VBATT rises above the LTH+ specification for at least 150ms.
_	4	LBOLH	Low-Battery Output Low/High, Active Low, Open Drain. <b>IBOLH</b> is asserted when V <sub>BATT</sub> drops below the LTH- specification. <b>IBOLH</b> is deasserted when V <sub>BATT</sub> rises above the HTH+ specification for at least 150ms.

## **Detailed Description**

The MAX6439–MAX6442 family is available with several monitoring options. The factory-trimmed thresholds eliminate the requirement for external components. The MAX6439/MAX6440 have single low-battery outputs and the MAX6441/MAX6442 have dual low-battery outputs (see Figure 1a and Figure 1b).

The MAX6439–MAX6442 combine a 1.23V reference with two comparators, logic, and timing circuitry to provide the user with information about the charge state of the power-supply batteries. The MAX6441/MAX6442

monitor separate high-voltage and low-voltage thresholds to determine battery status. The output(s) can be used to signal when the battery is charged, when the battery is low, and when the battery is empty. Factorytrimmed thresholds are ideal for monitoring single-cell Li+ or multicell alkaline/NiCd/NiMH power supplies.

When the power-supply voltage drops below the specified low threshold, the low-battery output asserts. When the voltage rises above the specified high threshold following a 150ms (min) timeout period, the low-battery output is deasserted. This ensures the supply voltage





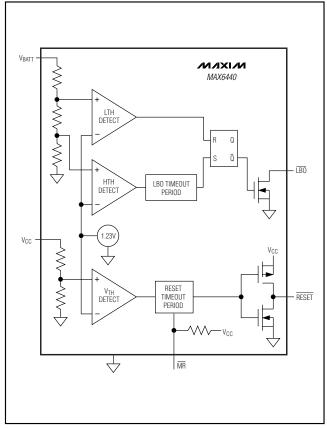


Figure 1a. Functional Diagram

has stabilized before power-converter or microprocessor activity is enabled.

These devices also have an independent  $\mu P$  supervisor that monitors  $V_{CC}$  and provides an active-low reset output. A manual reset function is available to allow the user to reset the  $\mu P$  with a push-button.

#### Low-Battery Output

The low-battery outputs are available in active-low (LBO, LBOL, LBOH, LBOLH), open-drain configurations. The low-battery outputs can be pulled to a voltage independent of V<sub>CC</sub> or V<sub>BATT</sub>, up to 5.5V. This allows the device to monitor and operate from direct battery voltage while interfacing to higher voltage microprocessors.

The MAX6439/MAX6440 single-output voltage monitors provide a single low-battery output, LBO. These fixed-threshold devices assert LBO when V<sub>BATT</sub> drops below V<sub>LTH</sub> and remain asserted for at least 150ms after V<sub>BATT</sub> rises above V<sub>HTH</sub> (see Figure 2). The MAX6441/MAX6442 triple-output voltage monitors provide three

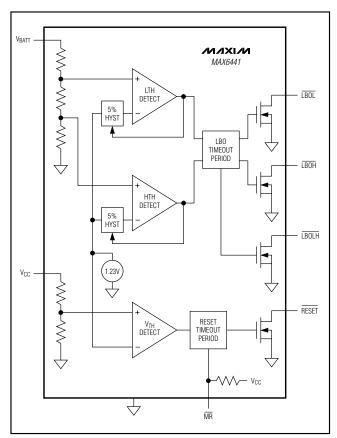


Figure 1b. Functional Diagram

low-battery outputs:  $\overline{LBOH}$ ,  $\overline{LBOL}$ , and  $\overline{LBOLH}$ .  $\overline{LBOH}$  asserts when VBATT drops below VHTH- and remains asserted for at least 150ms after VBATT rises above VHTH+.  $\overline{LBOL}$  asserts when VBATT drops below VLTH- and remains asserted for at least 150ms after VBATT rises above VLTH+.  $\overline{LBOLH}$  asserts when VBATT drops below VLTH- and remains asserted for at least 150ms after VBATT drops below VLTH- and remains asserted for at least 150ms after VBATT drops below VLTH- and remains asserted for at least 150ms after VBATT rises above VHTH+. (see Figure 3). For fast-rising VBATT input, the <u>LBOL</u> timeout period must complete before the <u>LBOH/LBOLH</u> timeout period begins.

#### **Reset Output**

The MAX6439–MAX6442 provide an active-low reset output (RESET). RESET is asserted when the voltage at V<sub>CC</sub> falls below the reset threshold level. Reset remains asserted for the reset timeout period after V<sub>CC</sub> exceeds the threshold. If V<sub>CC</sub> goes below the reset threshold before the reset timeout period is completed, the internal timer restarts. The MAX6439/MAX6441 have opendrain reset outputs, while the MAX6440/MAX6442 have push-pull reset outputs (see Figure 4).



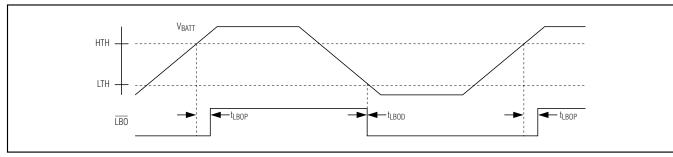


Figure 2. Single Low-Battery Output Timing

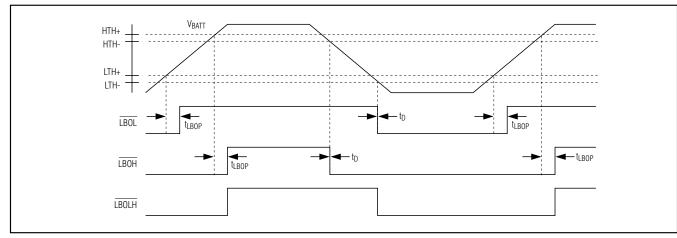


Figure 3. Dual Low-Battery Output Timing

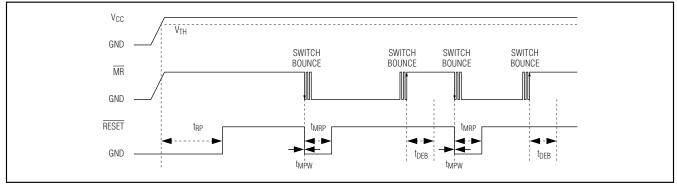


Figure 4. RESET Timing Diagram



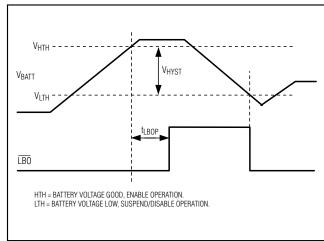


Figure 5. Hysteresis

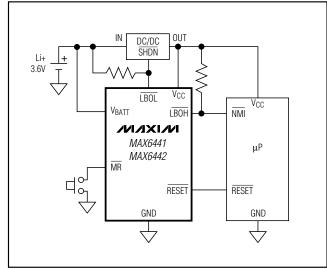


Figure 7. DC-to-DC Converter Application

#### Manual Reset

Many microprocessor-based products require manual reset capability, allowing the operator, a test technician, or external logic circuitry to initiate a reset while the monitored supplies remain above their reset thresholds. These devices have a dedicated active-low  $\overline{\text{MR}}$  pin. When  $\overline{\text{MR}}$  is pulled low,  $\overline{\text{RESET}}$  asserts a one-shot low pulse for the  $\overline{\text{MR}}$  reset timeout period. The  $\overline{\text{MR}}$  input has an internal 1.5k $\Omega$  pullup resistor to V<sub>CC</sub> and can be left unconnected if not used.  $\overline{\text{MR}}$  can be driven with CMOS-

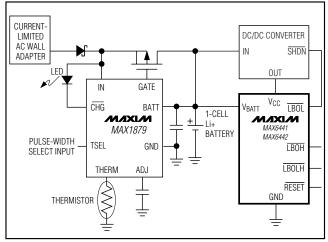


Figure 6. Li+ Charger Application (Using MAX1879)

logic levels, open-drain/open-collector outputs, or a momentary push-button switch to GND (the MR function is internally debounced for the  $t_{\underline{DEB}}$  timeout period) to create a manual reset function. If MR is driven from long cables, or if the device is used in a noisy environment, connect a 0.1µF capacitor from MR to GND to provide additional noise immunity (see Figure 4).

#### Hysteresis

Hysteresis increases the comparator's noise margin by increasing the upper threshold or decreasing the lower threshold. The hysteresis prevents the output from oscillating (chattering) when V<sub>BATT</sub> is near the low-battery threshold. This is especially important for applications where the load on the battery creates significant fluctuations in battery voltages (see Figure 5).

## **Applications Information**

#### Li+ Battery Charger Application

The MAX6441/MAX6442 dual-output battery monitors can be used in conjunction with a battery charger to provide a system with additional information about the battery charge state. Many battery chargers, such as the MAX1879, provide the user with a CHG output, which tells the system when the battery is charged. The MAX6441/MAX6442 dual-output battery monitors provide three outputs, which can be used to relay the battery condition to the system. This information is useful in determining which system resources can be powered by the battery at the current charge state (see Figure 6).



Table 1. Factory-Trimmed Lower and Upper Threshold Combinations for Single-Cell Li+ or Three-Cell Alkaline/NiCd/NiMH Applications

	VOLTAGES	UPPER THRESHOLD (HTH)					
	VOLTAGES	3.3V	3.4V	3.5V	3.6V		
	2.6V	AG	AH	AI	AJ		
LOWER THRESHOLD	2.7V	BG	BH	BI	BJ		
(LTH)	2.8V	CG	СН	CI	CJ		
()	2.9V	DG	DH	DI	DJ		
	3.0V	EG	EH	EI	EJ		
	3.1V	FG	FH	FI	FJ		

 Table 2. Factory-Trimmed Lower and Upper Threshold Combinations for Two-Cell

 Alkaline/NiCd/NiMH Applications

	VOLTAGES	UPPER THRESHOLD (HTH)				
	VOLTAGES	2.3V	2.4V	2.5V	2.6V	
	1.6V	KQ	KR	KS	KT	
LOWER THRESHOLD	1.7V	LQ	LR	LS	LT	
(LTH)	1.8V	MQ	MR	MS	MT	
()	1.9V	NQ	NR	NS	NT	
	2.0V	OQ	OR	OS	ОТ	
	2.1V	PQ	PR	PS	PT	

## Table 3. Factory-Trimmed VCC ResetThreshold Levels

PART NO. SUFFIX (_)	V <sub>CC</sub> NOMINAL RESET THRESHOLD (V)
Т	3.075
S	2.925
R	2.625
Z	2.313
Y	2.188
W	1.665
V	1.575

#### **DC-to-DC Converter Application**

The MAX6441/MAX6442 triple-output battery monitors can be used in conjunction with a DC-to-DC converter to power microprocessor systems using a single Li+ cell or two to three alkaline/NiCd/NiMH cells. The LBOH output indicates that the battery voltage is weak, and is used to warn the microprocessor of potential problems. Armed with this information, the microprocessor can

## Table 4. VCC Reset Timeout Period SuffixGuide

TIMEOUT	ACTIVE TIMEOUT PERIOD (ms)		
PERIOD SUFFIX	MIN	MAX	
D3	150	300	
D7	1200	2400	

reduce system power consumption. The  $\overline{LBOL}$  output indicates the battery is empty, and system power should be disabled. By connecting  $\overline{LBOL}$  to the SHDN pin of the DC-to-DC converter, power to the microprocessor is removed. Microprocessor power does not return until the battery has recharged to a voltage greater than V<sub>LTH+</sub> (see Figure 7).





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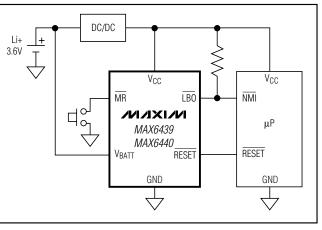
## **Selector Guide**

PART	OPEN-DRAIN RESET	PUSH-PULL RESET	SINGLE LOW- BATTERY OUTPUT	DUAL LOW-BATTERY OUTPUT
MAX6439	Х	—	Х	—
MAX6440	—	Х	Х	—
MAX6441	Х	—	—	Х
MAX6442	—	Х	—	Х

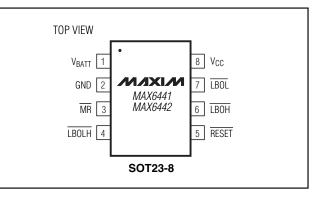
## **Standard Versions Table**

PART	TOP MARK
MAX6439UTDHRD3	ABMN
MAX6439UTDHSD3	ABMO
MAX6439UTEHRD3	ABMP
MAX6439UTEHSD3	ABMQ
MAX6439UTEIRD3	ABMR
MAX6439UTEISD3	ABMS
MAX6440UTDHRD3	ABMT
MAX6440UTDHSD3	ABMU
MAX6440UTEHRD3	ABMV
MAX6440UTEHSD3	ABMW
MAX6440UTEIRD3	ABMX
MAX6440UTEISD3	ABMY
MAX6441KADHRD3	AEEI
MAX6441KADHSD3	AEEJ
MAX6441KAEHRD3	AEEK
MAX6441KAEHSD3	AEEL
MAX6441KAEIRD3	AEEM
MAX6441KAEISD3	AEEN
MAX6442KADHRD3	AEEO
MAX6442KADHSD3	AEEP
MAX6442KAEHRD3	AEEQ
MAX6442KAEHSD3	AEER
MAX6442KAEIRD3	AEES
MAX6442KAEISD3	AEET

## **Typical Application Circuit**



## Pin Configurations (continued)

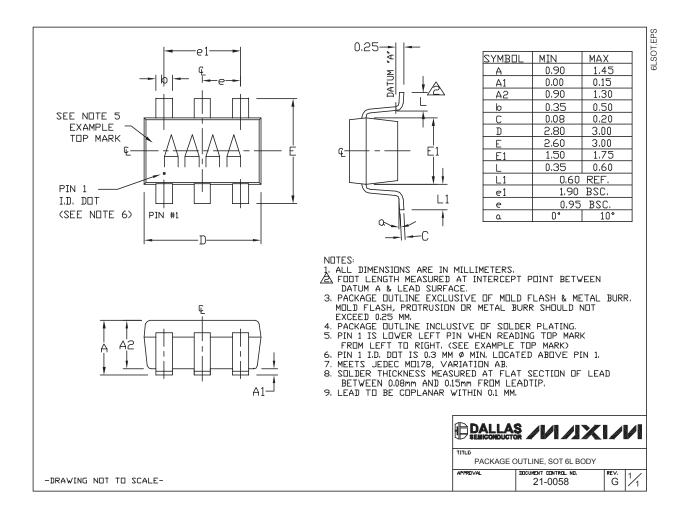


#### Chip Information

TRANSISTOR COUNT: 1478 PROCESS: BICMOS

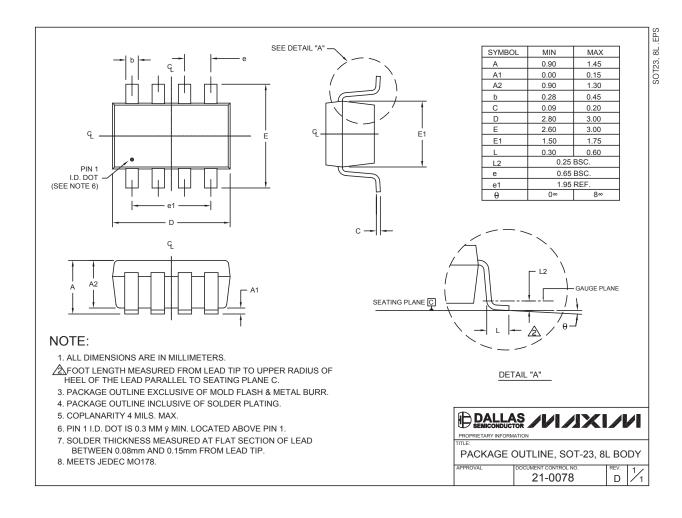
## **Package Information**

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to <u>www.maxim-ic.com/packages</u>.)



### Package Information (continued)

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